ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-America	ckburn, Illinois, A	ll rights reserved u utions.	nder both	This docume level parts, t	ent is a declara he declaration	ion of the s encompasse	ubstances es all lowe	within the man r level materials	ufacturer list s for which th	ed item. Note: ne manufacture	if the item is an a r has engineering	ssembly with lowe responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					s and Mfg Information			
Supplier Information													
bompany name* Company unique ID				Unique ID Authority					Resp	Response Date*			
onsemi	ai									2024-04-20			
Contact Name	Title - Contact]	Phone - Contact*				Ema	Email - Contact*			
Product-Env-Stewards	Env-Stewards Product Enviro Compliance			NA				Pro	Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative				Phone - Representative*				Ema	Email - Representative*				
Product-Env-Stewards Product Enviro Compliance			NA			Α			Pro	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr 1	tem Number	Mfr Item Name			Effective Date	e Version	1	Manufacturing S	acturing Site		UOM	Unit Type	
NCP	161AFCT500T2G CSP LDO 450mA, A		A, Active Dischar	rge	2024-04-20 Cl		CNQ		0.313731	mg	Each		
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base Alloy J-STI		J-STD-020 MSL	Rating	Peak Process Body Temperatur		re Max Time a	t Peak Temp	erature Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy 1		1		260		С	30	se	conds 3				
Comments													
evel 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds											
or more information regarding material composit	on please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weight			ance category (JIG or Requester) or ([F] Optionally enter the positive (+)				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Bump	0.0438	mg	Supplier	Tin (Sn)	7440-31-5		0.0108	mg
			Supplier	Copper (Cu)	7440-50-8		0.033	mg
Die	0.24779	mg	Supplier	Silicon (Si)	7440-21-3		0.2464	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0014	mg
Protection coat	0.00637	mg		Polyimide	proprietary data		0.0064	mg
Under Bump Metal	0.015771	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
		-	Supplier	Copper (Cu)	7440-50-8		0.0155	mg